

Electronic Patent Application Fee Transmittal

Application Number:	10038264			
Filing Date:	03-Jan-2002			
Title of Invention:	Solder interconnect techniques			
First Named Inventor:	Seungbae Park			
Filer:	George McGuire/Ann Miller			
Attorney Docket Number:	EN999048D			

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Extension - 1 month with \$0 paid	1251	1	120	120
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				120